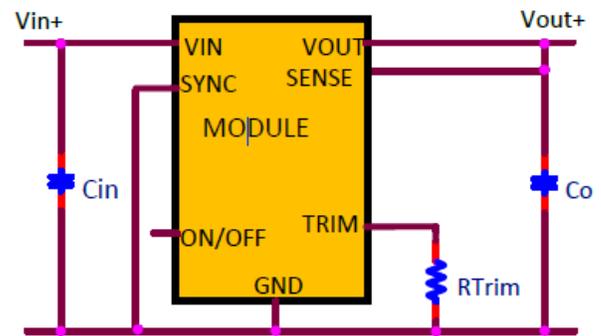


# IND108XW Hornet: Non-Isolated DC-DC Voltage Regulator Modules

**24V<sub>dc</sub> input; 3V<sub>dc</sub> to 18V<sub>dc</sub> output; 108W Max Power**



## Applications

- Industrial Equipment
- Control Boards
- Test Equipment

## Electrical Features

- 24V Input voltage with  $\pm 20\%$  Tolerance
- Output voltage programmable from 3V<sub>dc</sub> to 18V<sub>dc</sub> via external resistor
- Remote On/Off for optional external control
- Fixed switching frequency
- Sync Capability
- Output overcurrent protection (non-latching)

## Process and Safety

- Qualified for 1000h High Temperature Operating Bias, 1000h 85RH/85°C Temperature, Humidity and Bias, 700 cycle -40 to 125°C thermal cycling
- ANSI/UL\* 62368-1 and CAN/CSA† C22.2 No. 62368-1 Recognized, DIN VDE‡ 0868-1/A11:2017 (EN62368-1:2014/A11:2017)
- ISO\*\* 9001 and ISO 14001 certified manufacturing facilities
- Compliant to RoHS Directive 2011/65/EU and amended Directive (EU) 2015/863
- Compliant to REACH Directive (EC) No 1907/2006
- Compatible in a Pb-free or SnPb reflow environment.
- Suitable for aqueous clean.
- Suitable for conformal coating with dip and vapor deposition. Conformal coating can provide the protection to meet Salt. Fog Test per IEC 60068-2-52 (Severity 3) and Mixed Gas Flow test per Telcordia GR-3108 Outdoor Levels.
- 3 year warranty

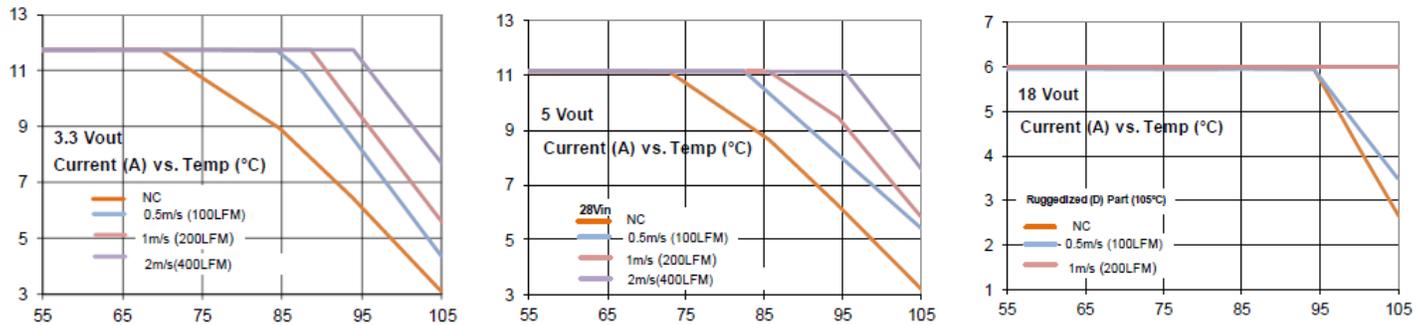
## Mechanical Features

- Small size: 33 mm x 13.46 mm x 10 mm (1.3 in x 0.53 in x 0.39 in)
- Operating range: -40°C to 105°C ambient
- Operating shock to 40G per Mil Std. 810G, Method 516.4 Procedure I
- Operating vibration per Mil Std. 810G, Method 514.5 Procedure I

Device Code	Input Voltage	Output Voltage	Output Current (Max.)	On/Off Logic	Ordering Code
IND108XW	19.2 – 28.8V <sub>dc</sub>	3.0 – 18.0V <sub>dc</sub>	12A(@3V <sub>out</sub> )	Negative	1600102907A

## Thermal Performance

Full rated output with natural convection up to 70°C at 3.3V<sub>out</sub> and up to 94°C at 18V<sub>out</sub>. Thermal curves for 3 voltages below.



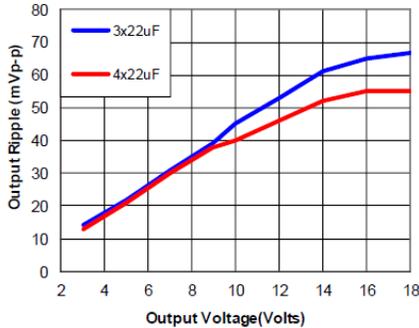
## Electrical Specifications

Parameter	Device	Symbol	Min	Typ	Max	Unit
Operating Input Voltage	All	V <sub>IN</sub>	19.2	24	28.8	V <sub>dc</sub>
Input No Load Current (V <sub>IN</sub> = 28.0V <sub>dc</sub> , I <sub>o</sub> = 0, module enabled)	V <sub>O,set</sub> = 3 V <sub>dc</sub>	I <sub>IN,No load</sub>		30		mA
	V <sub>O,set</sub> = 18V <sub>dc</sub>	I <sub>IN,No load</sub>		50		mA
External Capacitance, Ceramic ESR ≥ 1 mΩ	All	C <sub>O,max</sub>		–	100*	μF
Efficiency 28V <sub>INDC</sub> , T <sub>A</sub> =25°C, I <sub>o</sub> as per Figure 2		η	94(12V), 95.5(18V)			%
Switching Frequency	All	f <sub>sw</sub>	–	308	–	kHz
Output Voltage (Over all line, load, and temperature conditions)	All	V <sub>O,set</sub>	-2.5	–	+2.5	% V <sub>O,set</sub>
On/Off Logic High (MODULE OFF) Input High Voltage	All	V <sub>IH</sub>	1.8	–	36	V <sub>dc</sub>
On/ Off Logic Low (MODULE ON) Input Low Voltage	All	V <sub>IL</sub>	-0.2	–	0.3	V <sub>dc</sub>

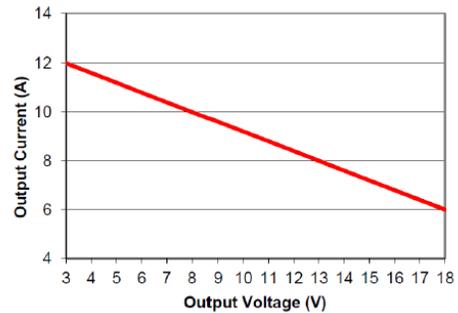
\*Additional External Capacitance possible using Tunable Loop

## Characteristic Curves

The following figures provide typical characteristics for the IND108XW Hornet at 25°C.



**Figure 1. Output Ripple Voltage for various output voltages and external caps @28V<sub>in</sub>. Additional Decoupling cap of 0.01μF used on input and output side.**



**Figure 2. Graph showing maximum output current capability at different output voltages.**

Use electrical profile in Figure 2 for determining baseline output current for a specific voltage. Then thermal curves.

## Trim

R<sub>trim</sub> for a desired output voltage, should be as per the following table. The formula in the last column helps determine R<sub>trim</sub> for other voltages.

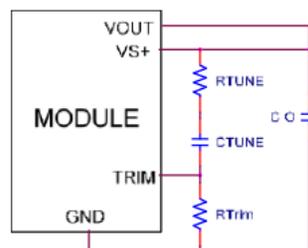
V <sub>o</sub> (V)	3.3	5.0	6	9	12	15	18	R <sub>trim</sub> = $\frac{70}{(V_o - 0.7)}$ kW
R <sub>trim</sub> (kΩ)	26.92	16.27	13.2	8.43	6.19	4.89	4.04	

## Safety Considerations

For safety agency approval, the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards listed on the first page of this document. For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV) or ES1, the input must meet SELV/ES1 requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV. The input to these units is to be provided with a fast-acting fuse with a maximum rating of 8A in the positive input lead.

## Tunable Loop

The module is designed for 47μF capacitor on its output. For applications where more than 47μF capacitors would be used on the output, an additional Resistor (R<sub>tune</sub>) and Capacitor (C<sub>tune</sub>) would be required in the circuit schematic to compensate for the additional capacitance. The placement is between the Sense+ pin and Trim pin as per figure below:



**Figure 3. Circuit diagram showing connection of R<sub>TUNE</sub> and C<sub>TUNE</sub> to tune the control loop of the module**



## Nozzle Recommendations

The minimum recommended inside nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 7 mm.

## Bottom Side/First Side Assembly

This module is not recommended for assembly on the bottom side of a customer board. If such an assembly is attempted, components may fall off the module during the second reflow process.

## Lead Free Soldering

The modules are lead-free (Pb-free) and RoHS compliant and fully compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

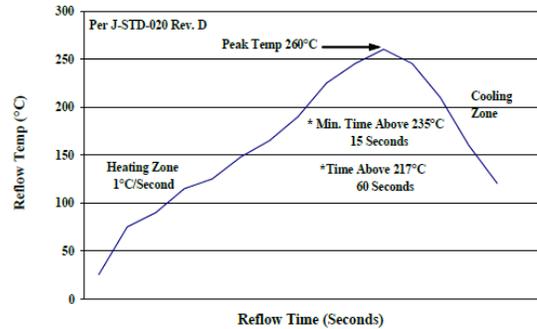
## MSL Rating

The modules have a MSL rating of 2a.

## Pb-free Reflow Profile

Power Systems will comply with J-STD-020 Rev. D (Moisture/Reflow Sensitivity Classification for Non hermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. The suggested Pb-free solder paste is Sn/Ag/Cu (SAC).

The following profile is the recommended linear reflow profile using Sn/Ag/Cu solder. Soldering outside of the recommended profile requires testing to verify results and performance.



## Storage and Handling

J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices) is recommended. Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of  $\leq 30^{\circ}\text{C}$  and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions:  $< 40^{\circ}\text{C}$ ,  $< 90\%$  relative humidity.

## Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly he following conditions:  $< 40^{\circ}\text{C}$ ,  $< 90\%$  relative humidity.

## Contact Us

For more information, call us at

1-877-546-3243 (US)

1-972-244-9288 (Int'l)

## Change History (excludes grammar & clarifications)

Revision	Date	Description of the change
5.3	09/30/2021	Updated as per template
5.4	12/11/2023	Updated as per OmniOn template

**OmniOn Power Inc.**

601 Shiloh Rd.  
Plano, TX USA

[omnionpower.com](http://omnionpower.com)

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